SIEMENS

Data sheet

6ES7312-1AE14-0AB0



SIMATIC S7-300, CPU 312 Central processing unit with MPI, Integr. power supply 24 V DC, Work memory 32 KB, Micro Memory Card required

Figuresimilar

General information	
HW functional status	01
Firmware version	V3.3
Engineering with	
 Programming package 	STEP 7 V5.5 + SP1 or higher or STEP 7 V5.2 + SP1 or higher with HSF 218
Supply voltage	
Rated value (DC)	24 V
permissible range, lower limit (DC)	19.2 V
permissible range, upper limit (DC)	28.8 V
external protection for power supply lines (recommendation)	2 A min.
Mains buffering	
Mains/voltage failure stored energy time	5 ms
Repeat rate, min.	1 s
Input current	
Current consumption (rated value)	650 mA
Current consumption (in no-load operation), typ.	140 mA
Inrush current, typ.	3.5 A
l²t	1 A ^{2.} s
Power loss	
Power loss, typ.	4 W
Memory	
Work memory	
integrated	32 kbyte
• expandable	No
Load memory	
• Plug-in (MMC)	Yes
• Plug-in (MMC), max.	8 Mbyte
 Data management on MMC (after last programming), min. 	10 a
Backup	
• present	Yes; Guaranteed by MMC (maintenance-free)
without battery	Yes; Program and data
CPU processing times	
for bit operations, typ.	0.1 µs
for word operations, typ.	0.24 µs
for fixed point arithmetic, typ.	0.32 µs
for floating point arithmetic, typ.	1.1 µs
CPU-blocks	

Number of blocks (total)	1 024; (DBs, FCs, FBs); the maximum number of loadable blocks can be reduced by the MMC used.
DB	
Number, max.	1 024; Number range: 1 to 16000
• Size, max.	32 kbyte
FB • Number, max.	1.024: Number range: 0 to 7000
 Number, max. Size, max. 	1 024; Number range: 0 to 7999 32 kbyte
FC	52 KDyle
Number, max.	1 024; Number range: 0 to 7999
• Size, max.	32 kbyte
OB	
Number, max.	see instruction list
• Size, max.	32 kbyte
 Number of free cycle OBs 	1; OB 1
 Number of time alarm OBs 	1; OB 10
 Number of delay alarm OBs 	2; OB 20, 21
 Number of cyclic interrupt OBs 	4; OB 32, 33, 34, 35
 Number of process alarm OBs 	1; OB 40
 Number of startup OBs 	1; OB 100
 Number of asynchronous error OBs 	4; OB 80, 82, 85, 87
Number of synchronous error OBs	2; OB 121, 122
Nesting depth	40
per priority class	16
additional within an error OB	4
Counters, timers and their retentivity	
S7 counter	
• Number	256
Retentivity	
— adjustable	Yes
— lower limit	0
— upper limit	255
— preset Counting range	Z 0 to Z 7
— lower limit	0
— upper limit	999
IEC counter	
• present	Yes
• Туре	SFB
• Number	Unlimited (limited only by RAM capacity)
S7 times	
Number	256
Retentivity	
— adjustable	Yes
— lower limit	0
— upper limit	255
— preset	No retentivity
Time range	
— lower limit	10 ms
— upper limit	9 990 s
IEC timer	Vec
• present	Yes
• Type • Number	SFB
	Unlimited (limited only by RAM capacity)
Data areas and their retentivity	20 khuta
Retentive data area (incl. timers, counters, flags), max.	32 kbyte
Flag	256 bito
Size, max. Petentivity available	256 byte Ves: MR 0 to MR 255
Retentivity availableRetentivity preset	Yes; MB 0 to MB 255 MB 0 to MB 15
Number of clock memories	8; 1 memory byte
Data blocks	
Retentivity adjustable	Yes; via non-retain property on DB
Retentivity preset	Yes

Local data	
• per priority class, max.	32 kbyte; Max. 2 KB per block
Address area	
I/O address area	
Inputs	1 024 byte
Outputs	1 024 byte
Process image	
Inputs	1 024 byte
Outputs	1 024 byte
Inputs, adjustable	1 024 byte
 Outputs, adjustable 	1 024 byte
 Inputs, default 	128 byte
Outputs, default	128 byte
Digital channels	
Inputs	256
— of which central	256
Outputs	256
— of which central	256
Analog channels	
Inputs	64
— of which central	64
Outputs — of which central	64 64
	04
Hardware configuration	
Number of expansion units, max.	0
Number of DP masters	
• integrated	0
• via CP	4
Number of operable FMs and CPs (recommended) • FM	0
● FM ● CP, PtP	8 8
• CP, LAN	6
Rack	4
Racks, max.	1
 Modules per rack, max. 	8
Time of day	
Clock	
Software clock	Yes
retentive and synchronizable	No; Buffered: No, Can be synchronized: Yes
• Deviation per day, max.	10 s; Typ.: 2 s
 Behavior of the clock following POWER-ON 	the clock continues at the time of day it had when power was switched
	off
Operating hours counter	
Number	1
Number/Number range	0
Range of values	0 to 2^31 hours (when using SFC 101)
• Granularity	1h
retentive	Yes; Must be restarted at each restart
Clock synchronization	Vee
supported to MDL montor	Yes
• to MPI, master	Yes
• to MPI, slave • in AS master	Yes
 in AS, master in AS, slave 	Yes No
Digital inputs	
Number of digital inputs	0
Digital outputs	
Number of digital outputs	0
Analog inputs	
Number of analog inputs	0
Analog outputs	
Number of analog outputs	0

Interfaces	
Number of industrial Ethernet interfaces	0
Number of PROFINET interfaces	0
Number of RS 485 interfaces	1; MPI
Number of RS 422 interfaces	0
1. Interface	
Interface type	Integrated RS 485 interface
Isolated	No
Interface types	
• RS 485	Yes
Output current of the interface, max.	200 mA
Protocols	Vec
MPI PROFIRIUS DR master	Yes
 PROFIBUS DP master PROFIBUS DP slave 	No No
 PROFIBUS DP slave Point-to-point connection 	No No
Point-to-point connection MPI	
Transmission rate, max.	187.5 kbit/s
Services	
— PG/OP communication	Yes
- Routing	No
- Global data communication	Yes
- S7 basic communication	Yes
— S7 communication	Yes; Only server, configured on one side
— S7 communication, as client	No
— S7 communication, as server	Yes
Protocols	
PROFIsafe	No
communication functions / header	
PG/OP communication	Yes
Data record routing	No
Global data communication	
• supported	Yes
Number of GD loops, max.	8
Number of GD packets, max.	8
 Number of GD packets, transmitter, max. Number of GD packets, receiver, max. 	8
 Number of GD packets, receiver, max. Size of GD packets, max. 	8 22 byte
 Size of GD packets, max. Size of GD packet (of which consistent), max. 	22 byte
S7 basic communication	
• supported	Yes
• User data per job, max.	76 byte
• User data per job (of which consistent), max.	76 byte; 76 bytes (with X_SEND or X_RCV); 64 bytes (with X_PUT or
	X_GET as server)
S7 communication	Van
• supported	Yes
as server as client	Yes Ves: Via CP and loadable EB
as clientUser data per job, max.	Yes; Via CP and loadable FB 180 byte; With PUT/GET
 User data per job (of which consistent), max. 	240 byte; with POT/GET
• Oser data per job (of which consistent), max. S5 compatible communication	
• supported	Yes; via CP and loadable FC
Number of connections	
• overall	6
 usable for PG communication 	5
 reserved for PG communication 	1
 adjustable for PG communication, min. 	1
	F
- adjustable for PG communication, max.	5
— adjustable for PG communication, max.usable for OP communication	5
 — adjustable for PG communication, max. usable for OP communication — reserved for OP communication 	5 1
 adjustable for PG communication, max. usable for OP communication reserved for OP communication adjustable for OP communication, min. 	5 1 1
 — adjustable for PG communication, max. usable for OP communication — reserved for OP communication 	5 1

- reserved for S7 basic communication	0
 adjustable for S7 basic communication, min. adjustable for S7 basic communication, max 	0 2
 — adjustable for S7 basic communication, max. S7 message functions 	2
	C: Depending on the configured connections for DC/OD and CZ basis
Number of login stations for message functions, max.	6; Depending on the configured connections for PG/OP and S7 basic communication
Process diagnostic messages	Yes
simultaneously active Alarm-S blocks, max.	300
Test commissioning functions	
Status block	Yes; Up to 2 simultaneously
Single step	Yes
Number of breakpoints	4
Status/control	
 Status/control variable 	Yes
Variables	Inputs, outputs, memory bits, DB, times, counters
 Number of variables, max. 	30
— of which status variables, max.	30
— of which control variables, max.	14
Forcing	
• Forcing	Yes
 Forcing, variables 	Inputs, outputs
 Number of variables, max. 	10
Diagnostic buffer	
• present	Yes
Number of entries, max.	500
— adjustable	No
— of which powerfail-proof	100; Only the last 100 entries are retained
 Number of entries readable in RUN, max. 	499
— adjustable	Yes; From 10 to 499
— preset	10
Service data	10
• can be read out	Yes
	165
Ambient conditions	
Ambient conditions	
Ambient temperature during operation	0.10
Ambient temperature during operation min. 	0°C
Ambient temperature during operation min. max. 	0 °C 60 °C
Ambient temperature during operation min. max. configuration / header	
Ambient temperature during operation min. max. configuration / header Configuration software 	60 °C
Ambient temperature during operation min. max. configuration / header Configuration software STEP 7 	
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Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 configuration / programming / header • Command set • Nesting levels • System functions (SFC) • System function blocks (SFB) Programming language - LAD - FBD - STL - SCL	60 °C Yes; V5.2 SP1 or higher with HW update see instruction list 8 see instruction list see instruction list Yes Yes
Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 configuration / programming / header • Command set • Nesting levels • System functions (SFC) • System function blocks (SFB) Programming language - LAD - FBD - STL - SCL - GRAPH	60 °C Yes; V5.2 SP1 or higher with HW update see instruction list 8 see instruction list see instruction list Yes Yes Yes Yes Yes Yes Yes
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Ambient temperature during operation • min. • max. configuration / header Configuration software • STEP 7 configuration / programming / header • Command set • Nesting levels • System functions (SFC) • System function blocks (SFB) Programming language - LAD - FBD - STL - SCL - GRAPH - HiGraph® Know-how protection • Block encryption Dimensions Width Height Depth	60 °C Yes; V5.2 SP1 or higher with HW update see instruction list 8 see instruction list see instruction list Yes
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